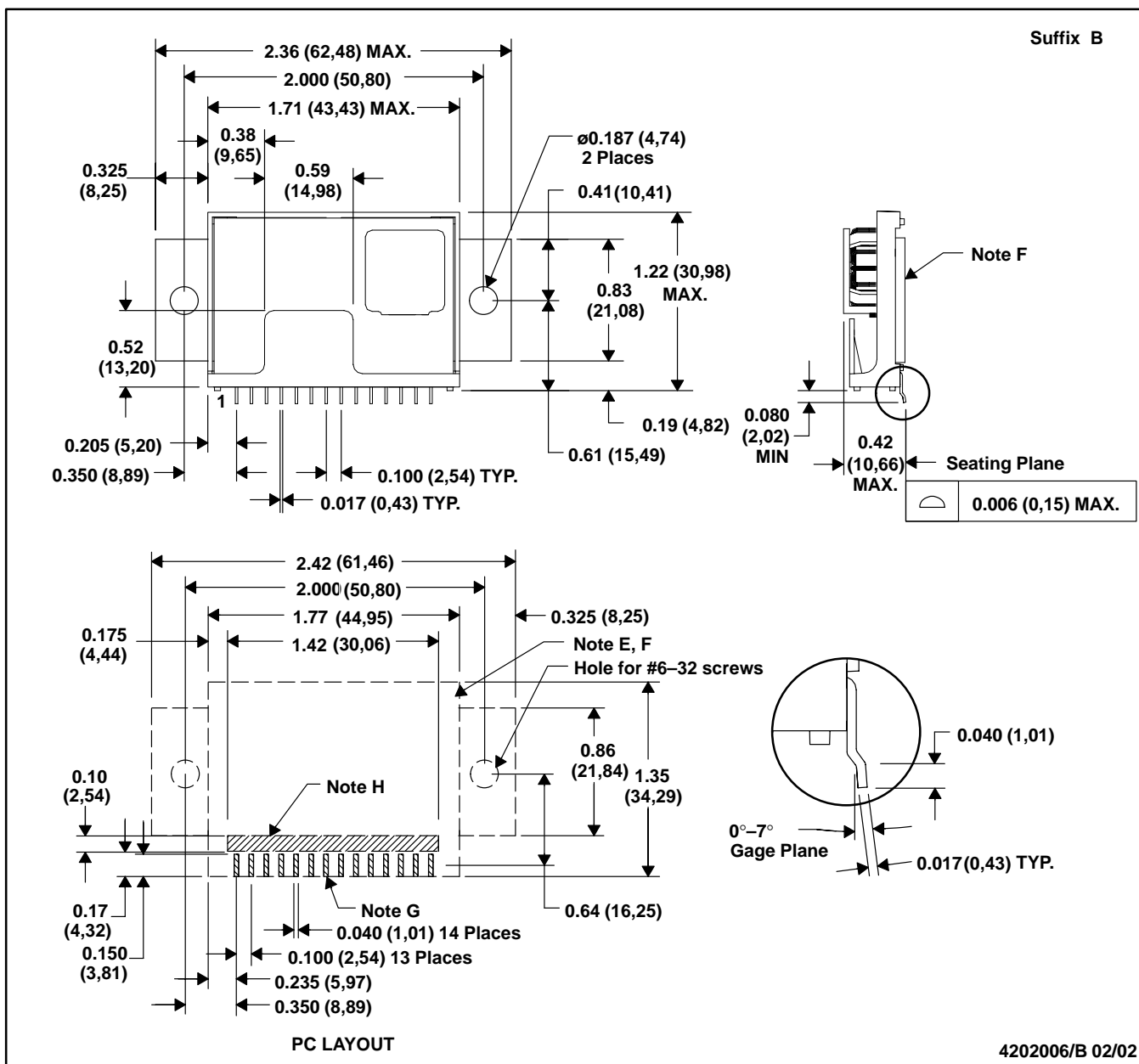


EEK (R-PSIP-G14)

PLASTIC SINGLE-IN-LINE MODULE



- NOTES: A. All linear dimensions are in inches (mm).
 B. This drawing is subject to change without notice.
 C. 2-place decimals are ± 0.030 ($\pm 0,76$ mm).
 D. 3-place decimals are ± 0.010 ($\pm 0,25$ mm).
 E. Recommended mechanical keep-out area.
 F. The metal tab is isolated but electrically conductive.
 No signal traces are allowed under the metal tab area.
 A solid copper island is recommended, which may be grounded.

- G. Power pin connections should utilize two or more vias per input, ground and output pin.
 H. No copper, power or signal traces in this area.

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Mailing Address:

Texas Instruments
Post Office Box 655303
Dallas, Texas 75265